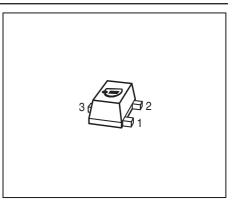


BFR193F

Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain amplifiers up to 2 GHz
- For linear broadband amplifiers
- $f_{\rm T}$ = 8 GHz, $NF_{\rm min}$ = 1 dB at 900 MHz
- Pb-free (RoHS compliant) and halogen-free product
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pir	Package		
BFR193F	RCs	1 = B	2 = E	3 = C	TSFP-3

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	80	mA
Base current	IB	10	
Total power dissipation ¹⁾	P _{tot}	580	mW
<i>T</i> _S ≤ 72°C			
Junction temperature	TJ	150	°C
Storage temperature	T _{Stq}	-55 150	
	· - ··· ·		•

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	135	K/W

 $^{1}\mathcal{T}_{S}$ is measured on the collector lead at the soldering point to the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.	1
DC Characteristics				•	
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
<i>V</i> _{EB} = 1 V, <i>I</i> _C = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol				Unit	
		min.	typ.	max.		
AC Characteristics (verified by random sampling)						
Transition frequency	f _T	6	8	-	GHz	
<i>I</i> _C = 50 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz						
Collector-base capacitance	C _{cb}	-	0.63	1	pF	
V_{CB} = 10 V, f = 1 MHz, V_{BE} = 0, emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.25	-		
V_{CE} = 10 V, f = 1 MHz, V_{BE} = 0, base grounded						
Emitter-base capacitance	C _{eb}	-	2.25	-		
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,						
collector grounded						
Minimum noise figure	NF _{min}				dB	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 900 MHz		-	1	-		
<i>f</i> = 1.8 GHz		-	1.6	-		
Power gain, maximum stable ¹⁾	G _{ms}	-	12.5	-	dB	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 900 \rm MHz$						
Power gain, maximum available ¹⁾	G _{ma}	-	19	-	dB	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 1.8 {\rm GHz}$						
Transducer gain	S _{21e} ²				dB	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ =50 Ω , f = 900 MHz		-	14.5	-		
<i>f</i> = 1.8 GHz		-	8.5	-		
Third order intercept point at output ²⁾	IP ₃	-	29	-	dBm	
V _{CE} = 8 V, <i>I</i> _C = 30 mA, <i>f</i> = 900 MHz,						
$Z_{\rm S} = Z_{\rm L} = 50 \ \Omega$						
1dB compression point at output ³⁾	P _{-1dB}	-	14.5	-	1	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
f = 900 MHz						
	+		•	·		

Electrical Characteristics at T_A	= 25 °C	unless	otherwise	specified
	0,	unicoo	0010100130	Specificu

 ${}^{1}G_{\rm ma} = |S_{21} / S_{12}| \ (k - (k^2 - 1)^{1/2}), \ G_{\rm ms} = |S_{21} / S_{12}|$

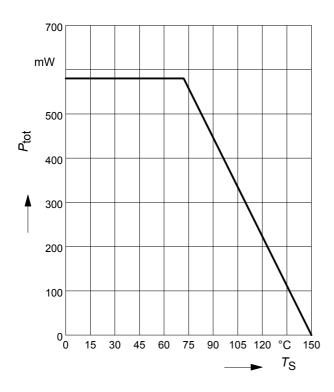
²IP3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz

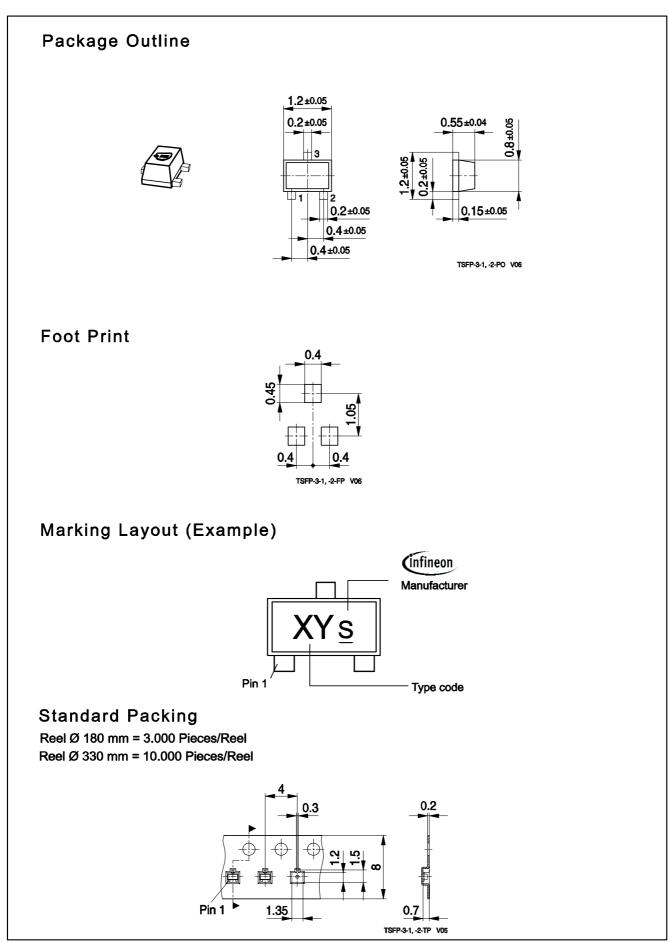
³DC current at no input power



Total power dissipation $P_{tot} = f(T_S)$









Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<<u>www.infineon.com</u>>).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon: BFR193FH6327XTSA1